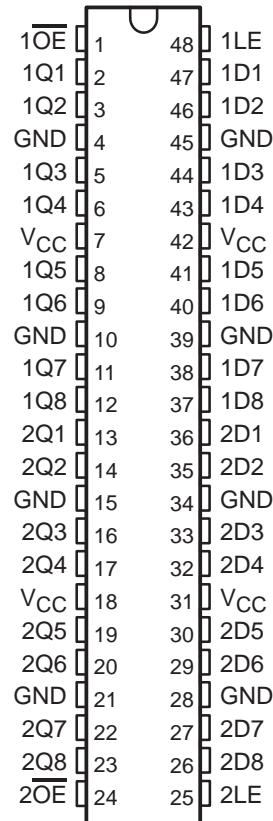


SN54ALVTH16373, SN74ALVTH16373 2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

- State-of-the-Art Advanced BiCMOS Technology (ABT) *Widebus*™ Design for 2.5-V and 3.3-V Operation and Low Static Power Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 2.3-V to 3.6-V V_{CC})
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- High Drive ($-24/24$ mA at 2.5-V and $-32/64$ mA at 3.3-V V_{CC})
- Power Off Disables Outputs, Permitting Live Insertion
- High-Impedance State During Power Up and Power Down Prevents Driver Conflict
- Uses Bus Hold on Data Inputs in Place of External Pullup/Pulldown Resistors to Prevent the Bus From Floating
- Auto3-State Eliminates Bus Current Loading When Output Exceeds $V_{CC} + 0.5$ V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model; and Exceeds 1000 V Using Charged-Device Model, Robotic Method
- Flow-Through Architecture Facilitates Printed Circuit Board Layout
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

SN54ALVTH16373 . . . WD PACKAGE
SN74ALVTH16373 . . . DGG, DGV, OR DL PACKAGE
(TOP VIEW)



description

The 'ALVTH16373 devices are 16-bit transparent D-type latches with 3-state outputs designed for 2.5-V or 3.3-V V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

These devices can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments Incorporated.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1999, Texas Instruments Incorporated

SN54ALVTH16373, SN74ALVTH16373

2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

description (continued)

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without interface or pullup components.

\overline{OE} does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ALVTH16373 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALVTH16373 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each 8-bit section)

| INPUTS | | | OUTPUT Q |
|-----------------|----|---|-------------|
| \overline{OE} | LE | D | |
| L | H | H | H |
| L | H | L | L |
| L | L | X | Q_0 |
| H | X | X | Z |

SN54ALVTH16373, SN74ALVTH16373

2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| | |
|--|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 4.6 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high state, V_O (see Note 1) | –0.5 V to 7 V |
| Output current in the low state, I_O : SN54ALVTH16373 | 96 mA |
| SN74ALVTH16373 | 128 mA |
| Output current in the high state, I_O : SN54ALVTH16373 | –48 mA |
| SN74ALVTH16373 | –64 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –50 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DGG package | 89°C/W |
| DGV package | 93°C/W |
| DL package | 94°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Note 3)

| | | SN54ALVTH16373 | | | SN74ALVTH16373 | | | UNIT |
|--------------------------|---|----------------|----------|-----|----------------|----------|-----|-----------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{CC} | Supply voltage | 2.3 | | 2.7 | 2.3 | | 2.7 | V |
| V_{IH} | High-level input voltage | 1.7 | | | 1.7 | | | V |
| V_{IL} | Low-level input voltage | | | 0.7 | | | 0.7 | V |
| V_I | Input voltage | 0 | V_{CC} | 5.5 | 0 | V_{CC} | 5.5 | V |
| I_{OH} | High-level output current | | | –6 | | | –8 | mA |
| I_{OL} | Low-level output current | | | 6 | | | 8 | mA |
| | Low-level output current; current duty cycle $\leq 50\%$; $f \geq 1 \text{ kHz}$ | | | 18 | | | 24 | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | | | 10 | | | 10 | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate | 200 | | | 200 | | | $\mu\text{s/V}$ |
| T_A | Operating free-air temperature | –55 | | 125 | –40 | | 85 | °C |

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54ALVTH16373, SN74ALVTH16373

2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

recommended operating conditions, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (see Note 3)

| | | SN54ALVTH16373 | | | SN74ALVTH16373 | | | UNIT |
|--------------------------|--|-----------------|----------|-----|----------------|----------|-----|--------------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{CC} | Supply voltage | 3 | | 3.6 | 3 | | 3.6 | V |
| V_{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V_I | Input voltage | 0 | V_{CC} | 5.5 | 0 | V_{CC} | 5.5 | V |
| I_{OH} | High-level output current | | | –24 | | | –32 | mA |
| I_{OL} | Low-level output current | | | 24 | | | 32 | mA |
| | Low-level output current; current duty cycle $\leq 50\%$; $f \geq 1\text{ kHz}$ | | | 48 | | | 64 | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | | 10 | | | 10 | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate | 200 | | | 200 | | | $\mu\text{s/V}$ |
| T_A | Operating free-air temperature | –55 | | 125 | –40 | | 85 | $^{\circ}\text{C}$ |

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54ALVTH16373, SN74ALVTH16373
2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES
WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

electrical characteristics over recommended operating free-air temperature range,
 $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | SN54ALVTH16373 | | | SN74ALVTH16373 | | | UNIT |
|-----------------------|----------------|---|------------------|-----------|---------|----------------|-----------|-----------|---------------|
| | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| V_{IK} | | $V_{CC} = 2.3 \text{ V}$, $I_I = -18 \text{ mA}$ | | | -1.2 | | | -1.2 | V |
| V_{OH} | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$, $I_{OH} = -100 \mu\text{A}$ | $V_{CC}-0.2$ | | | $V_{CC}-0.2$ | | | V |
| | | $V_{CC} = 2.3 \text{ V}$, $I_{OH} = -6 \text{ mA}$ | 1.8 | | | | | | |
| | | $V_{CC} = 2.3 \text{ V}$, $I_{OH} = -8 \text{ mA}$ | | | | 1.8 | | | |
| V_{OL} | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$, $I_{OL} = 100 \mu\text{A}$ | | | 0.2 | | | 0.2 | V |
| | | $V_{CC} = 2.3 \text{ V}$ | | | 0.4 | | | | |
| | | | | | | | | 0.4 | |
| | | | | | 0.5 | | | | |
| | | | | | | | | 0.5 | |
| I_I | Control inputs | $V_{CC} = 2.7 \text{ V}$, $V_I = V_{CC} \text{ or GND}$ | | | ± 1 | | | ± 1 | μA |
| | | $V_{CC} = 0 \text{ or } 2.7 \text{ V}$, $V_I = 5.5 \text{ V}$ | | | 10 | | | 10 | |
| | Data inputs | $V_{CC} = 2.7 \text{ V}$ | | | 10 | | | 10 | |
| | | | | | 1 | | | 1 | |
| | | | | | -5 | | | -5 | |
| I_{off} | | $V_{CC} = 0$, $V_I \text{ or } V_O = 0 \text{ to } 4.5 \text{ V}$ | | | | | | ± 100 | μA |
| I_{BHL}^\ddagger | | $V_{CC} = 2.3 \text{ V}$, $V_I = 0.7 \text{ V}$ | | 115 | | | 115 | | μA |
| I_{BHH}^\S | | $V_{CC} = 2.3 \text{ V}$, $V_I = 1.7 \text{ V}$ | | -10 | | | -10 | | μA |
| I_{BHLO}^\P | | $V_{CC} = 2.7 \text{ V}$, $V_I = 0 \text{ to } V_{CC}$ | 300 | | | 300 | | | μA |
| $I_{BHHO}^\#$ | | $V_{CC} = 2.7 \text{ V}$, $V_I = 0 \text{ to } V_{CC}$ | -300 | | | -300 | | | μA |
| I_{EX}^{\parallel} | | $V_{CC} = 2.3 \text{ V}$, $V_O = 5.5 \text{ V}$ | | 125 | | | 125 | | μA |
| $I_{OZ(PU/PD)}^\star$ | | $V_{CC} \leq 1.2 \text{ V}$, $V_O = 0.5 \text{ V to } V_{CC}$, $V_I = \text{GND or } V_{CC}$, $\overline{OE} = \text{don't care}$ | | ± 100 | | | ± 100 | | μA |
| I_{OZH} | | $V_{CC} = 2.7 \text{ V}$, $V_O = 2.3 \text{ V}$, $V_I = 0.7 \text{ V or } 1.7 \text{ V}$ | | 5 | | | 5 | | μA |
| I_{OZL} | | $V_{CC} = 2.7 \text{ V}$, $V_O = 0.5 \text{ V}$, $V_I = 0.7 \text{ V or } 1.7 \text{ V}$ | | -5 | | | -5 | | μA |
| I_{CC} | | $V_{CC} = 2.7 \text{ V}$, $I_O = 0$, $V_I = V_{CC} \text{ or GND}$ | Outputs high | 0.04 | 0.1 | 0.04 | 0.1 | | mA |
| | | | Outputs low | 2.3 | 4.5 | 2.3 | 4.5 | | |
| | | | Outputs disabled | 0.04 | 0.1 | 0.04 | 0.1 | | |
| C_i | | $V_{CC} = 2.5 \text{ V}$, $V_I = 2.5 \text{ V or } 0$ | | 3.5 | | | 3.5 | | pF |
| C_o | | $V_{CC} = 2.5 \text{ V}$, $V_O = 2.5 \text{ V or } 0$ | | 6 | | | 6 | | pF |

† All typical values are at $V_{CC} = 2.5 \text{ V}$, $T_A = 25^\circ\text{C}$.

‡ The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

§ The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

¶ An external driver must source at least I_{BHLO} to switch this node from low to high.

An external driver must sink at least I_{BHHO} to switch this node from high to low.

|| Current into an output in the high state when $V_O > V_{CC}$

☆ High-impedance state during power up or power down

SN54ALVTH16373, SN74ALVTH16373

2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

**electrical characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted)**

| PARAMETER | | TEST CONDITIONS | | SN54ALVTH16373 | | | SN74ALVTH16373 | | | UNIT | |
|--------------------------|----------------|---|---|--------------------------|------|------|----------------------|------|-----|------|----|
| | | | | MIN | TYP† | MAX | MIN | TYP† | MAX | | |
| V _{IK} | | V _{CC} = 3 V, I _I = –18 mA | | –1.2 | | | –1.2 | | | V | |
| V _{OH} | | V _{CC} = 3 V to 3.6 V, I _{OH} = –100 μA | | V _{CC} –0.2 | | | V _{CC} –0.2 | | | V | |
| | | V _{CC} = 3 V | | I _{OH} = –24 mA | | | | | | | |
| | | | | I _{OH} = –32 mA | | | 2 | | | | |
| V _{OL} | | V _{CC} = 3 V to 3.6 V, I _{OL} = 100 μA | | 0.2 | | | 0.2 | | | V | |
| | | V _{CC} = 3 V | | I _{OL} = 16 mA | | | 0.4 | | | | |
| | | | | I _{OL} = 24 mA | | | 0.5 | | | | |
| | | | | I _{OL} = 32 mA | | | 0.5 | | | | |
| | | | | I _{OL} = 48 mA | | | 0.55 | | | | |
| | | | | I _{OL} = 64 mA | | | 0.55 | | | | |
| I _I | Control inputs | V _{CC} = 3.6 V, V _I = V _{CC} or GND | | ±1 | | | ±1 | | | μA | |
| | | V _{CC} = 0 or 3.6 V, V _I = 5.5 V | | 10 | | | 10 | | | | |
| | Data inputs | V _I = 5.5 V | | 10 | | | 10 | | | | |
| | | V _{CC} = 3.6 V, V _I = V _{CC} | | 1 | | | 1 | | | | |
| | | V _I = 0 | | –5 | | | –5 | | | | |
| I _{off} | | V _{CC} = 0, V _I or V _O = 0 to 4.5 V | | | | | ±100 | | | μA | |
| I _{BHL} ‡ | | V _{CC} = 3 V, V _I = 0.8 V | | 75 | | | 75 | | | μA | |
| I _{BHH} § | | V _{CC} = 3 V, V _I = 2 V | | –75 | | | –75 | | | μA | |
| I _{BHLO} ¶ | | V _{CC} = 3.6 V, V _I = 0 to V _{CC} | | 500 | | | 500 | | | μA | |
| I _{BHHO} # | | V _{CC} = 3.6 V, V _I = 0 to V _{CC} | | –500 | | | –500 | | | μA | |
| I _{EX} | | V _{CC} = 3 V, V _O = 5.5 V | | 125 | | | 125 | | | μA | |
| I _{OZ} (PU/PD)★ | | V _{CC} ≤ 1.2 V, V _O = 0.5 V to V _{CC} , V _I = GND or V _{CC} , \overline{OE} = don't care | | ±100 | | | ±100 | | | μA | |
| I _{OZH} | | V _{CC} = 3.6 V | V _O = 3 V, V _I = 0.8 V or 2 V | 5 | | | 5 | | | μA | |
| I _{OZL} | | V _{CC} = 3.6 V | V _O = 0.5 V, V _I = 0.8 V or 2 V | –5 | | | –5 | | | μA | |
| I _{CC} | | V _{CC} = 3.6 V, I _O = 0, V _I = V _{CC} or GND | | Outputs high | | 0.07 | 0.1 | 0.07 | | 0.1 | mA |
| | | | | Outputs low | | 3.2 | 5.5 | 3.2 | | 5 | |
| | | | | Outputs disabled | | 0.07 | 0.1 | 0.07 | | 0.1 | |
| ΔI _{CC} □ | | V _{CC} = 3 V to 3.6 V, One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND | | 0.4 | | | 0.4 | | | mA | |
| C _i | | V _{CC} = 3.3 V, V _I = 3.3 V or 0 | | 3.5 | | | 3.5 | | | pF | |
| C _O | | V _{CC} = 3.3 V, V _O = 3.3 V or 0 | | 6 | | | 6 | | | pF | |

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

§ The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

¶ An external driver must source at least I_{BHLO} to switch this node from low to high.

An external driver must sink at least I_{BHHO} to switch this node from high to low.

|| Current into an output in the high state when V_O > V_{CC}

★ High-impedance state during power up or power down

□ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



SN54ALVTH16373, SN74ALVTH16373
2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES
WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

timing requirements over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

| | | | SN54ALVTH16373 | | SN74ALVTH16373 | | UNIT |
|----------|-----------------------------|-----------|----------------|-----|----------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_W | Pulse duration, LE high | | 1.5 | | 1.5 | | ns |
| t_{su} | Setup time, data before LE↓ | Data high | 1.1 | | 1 | | ns |
| | | Data low | 1.6 | | 1.5 | | |
| t_h | Hold time, data after LE↓ | Data high | 1 | | 0.9 | | ns |
| | | Data low | 1.6 | | 1.5 | | |

timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 2)

| | | | SN54ALVTH16373 | | SN74ALVTH16373 | | UNIT |
|----------|-----------------------------|-----------|----------------|-----|----------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_W | Pulse duration, LE high | | 1.5 | | 1.5 | | ns |
| t_{su} | Setup time, data before LE↓ | Data high | 1.5 | | 1.4 | | ns |
| | | Data low | | | 0.9 | | |
| t_h | Hold time, data after LE↓ | Data high | 1 | | 0.9 | | ns |
| | | Data low | 1.5 | | 1.4 | | |

switching characteristics over recommended operating free-air temperature range, $C_L = 30\text{ pF}$, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ALVTH16373 | | SN74ALVTH16373 | | UNIT |
|-----------|-----------------|-------------|----------------|-----|----------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_{PLH} | D | Q | 1 | 3.4 | 1 | 3.3 | ns |
| t_{PHL} | | | 1 | 4.3 | 1 | 4.2 | |
| t_{PLH} | LE | Q | 1.4 | 3.9 | 1.5 | 3.8 | ns |
| t_{PHL} | | | 1.4 | 4.6 | 1.5 | 4.5 | |
| t_{PZH} | \overline{OE} | Q | 1.7 | 4.4 | 1.8 | 4.3 | ns |
| t_{PZL} | | | 1.4 | 4.1 | 1.5 | 4 | |
| t_{PHZ} | OE | Q | 1.4 | 4.7 | 1.5 | 4.6 | ns |
| t_{PLZ} | | | 1 | 3.7 | 1 | 3.6 | |

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ALVTH16373 | | SN74ALVTH16373 | | UNIT |
|-----------|-----------------|-------------|----------------|-----|----------------|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| t_{PLH} | D | Q | 1 | 3.2 | 1 | 3.1 | ns |
| t_{PHL} | | | 1 | 3.4 | 1 | 3.3 | |
| t_{PLH} | LE | Q | 1 | 3.4 | 1 | 3.3 | ns |
| t_{PHL} | | | 1 | 3.6 | 1 | 3.5 | |
| t_{PZH} | \overline{OE} | Q | 1.3 | 4.1 | 1.4 | 4 | ns |
| t_{PZL} | | | 1 | 3.5 | 1 | 3.4 | |
| t_{PHZ} | \overline{OE} | Q | 1.4 | 5 | 1.5 | 4.9 | ns |
| t_{PLZ} | | | 1.4 | 4.6 | 1.5 | 4.5 | |

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54ALVTH16373, SN74ALVTH16373

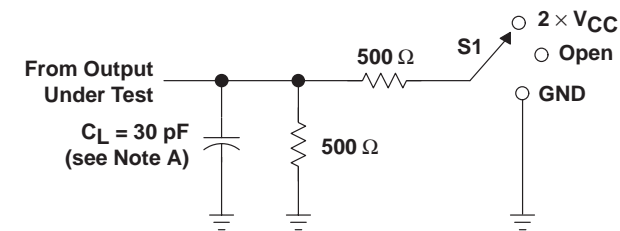
2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES

WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

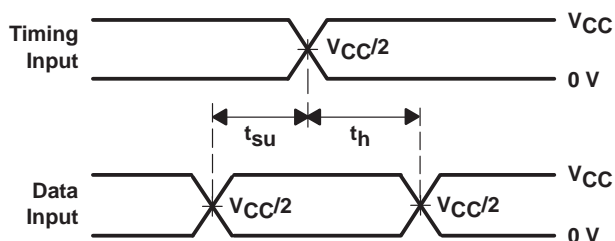
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

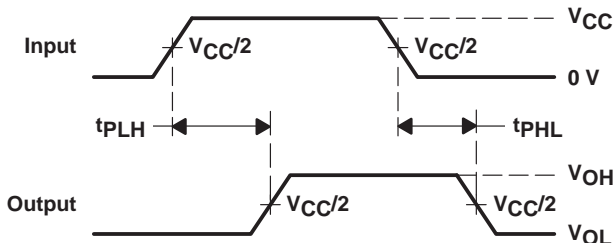


LOAD CIRCUIT

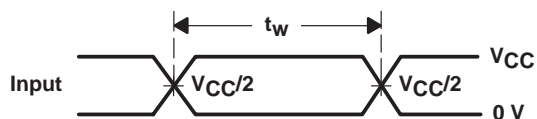
| TEST | S1 |
|-------------------|-------------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 2 $\times V_{CC}$ |
| t_{PHZ}/t_{PZH} | GND |



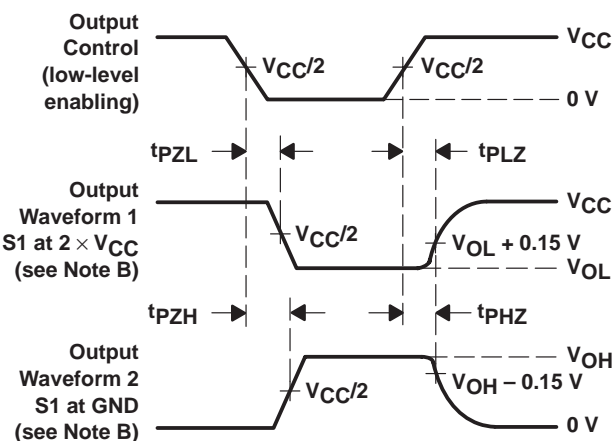
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.

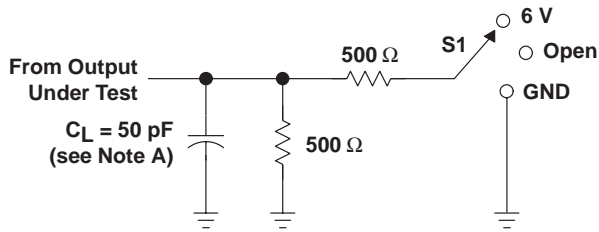
Figure 1. Load Circuit and Voltage Waveforms

SN54ALVTH16373, SN74ALVTH16373 2.5-V/3.3-V 16-BIT TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCES067F – JUNE 1996 – REVISED JANUARY 1999

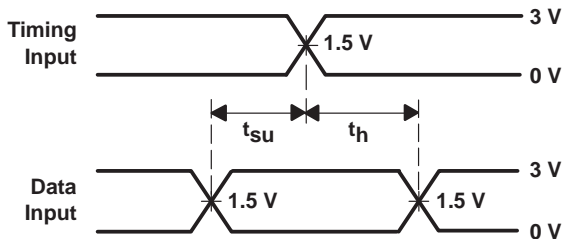
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$

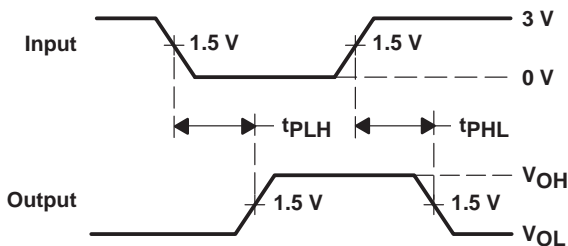


LOAD CIRCUIT

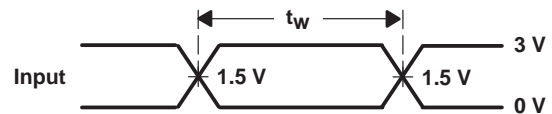
| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 6 V |
| t_{PHZ}/t_{PZH} | GND |



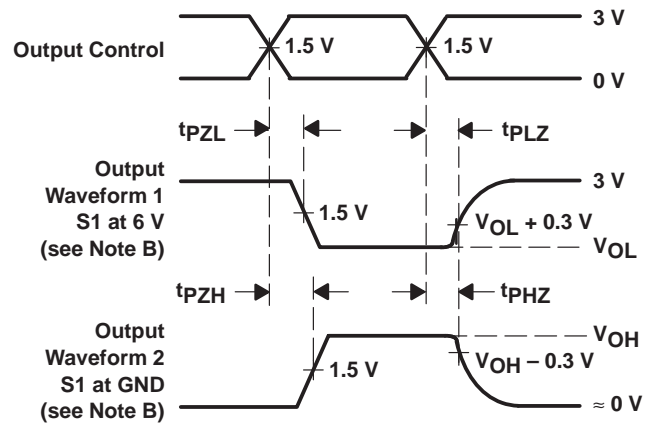
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN74ALVTH16373DL | Obsolete | Production | SSOP (DL) 48 | - | - | Call TI | Call TI | -40 to 85 | ALVTH16373 |
| SN74ALVTH16373DLR | Obsolete | Production | SSOP (DL) 48 | - | - | Call TI | Call TI | -40 to 85 | ALVTH16373 |
| SN74ALVTH16373GR | Obsolete | Production | TSSOP (DGG) 48 | - | - | Call TI | Call TI | -40 to 85 | ALVTH16373 |
| SN74ALVTH16373VR | Obsolete | Production | TVSOP (DGV) 48 | - | - | Call TI | Call TI | -40 to 85 | VT373 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

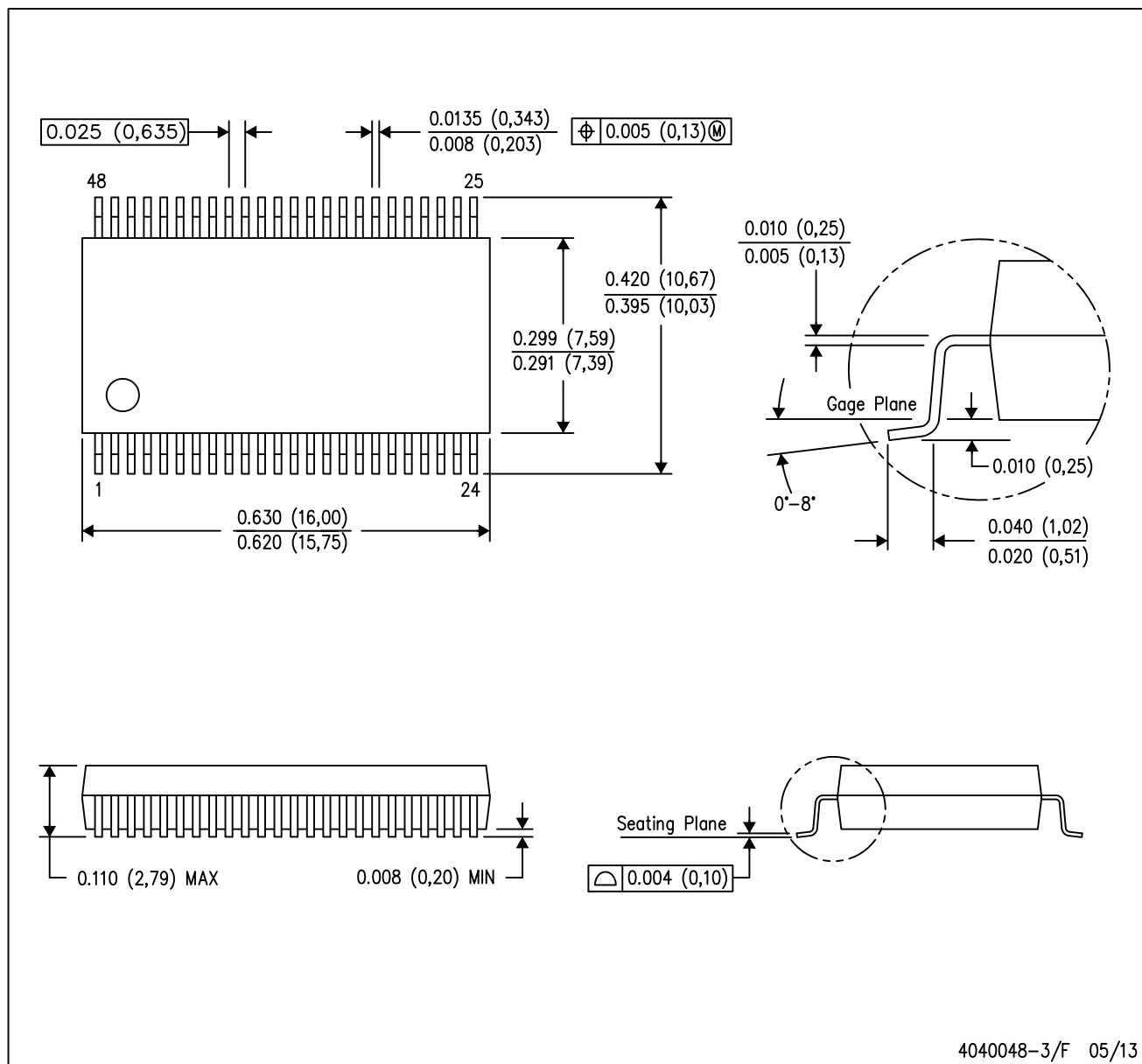
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MO-118

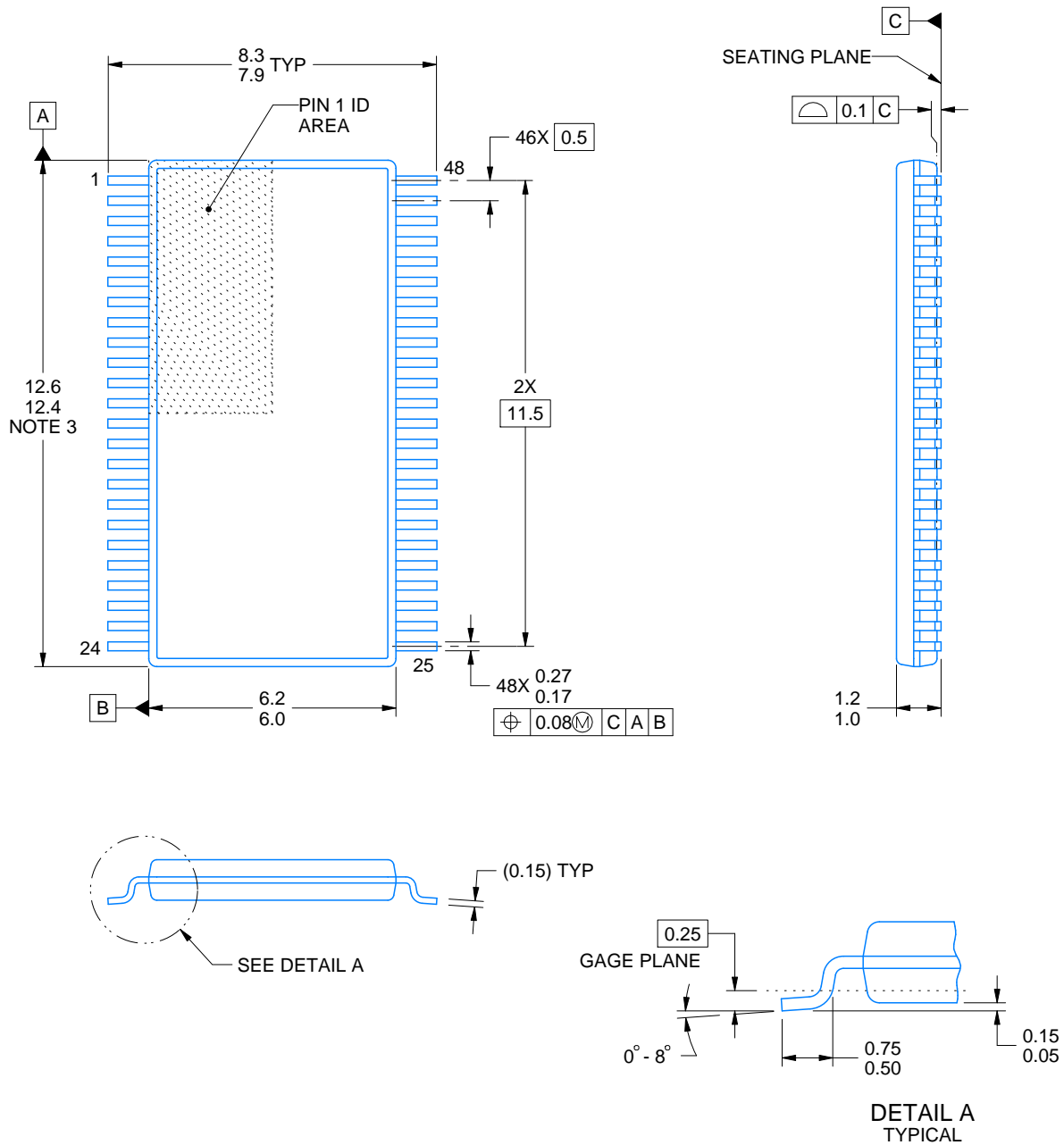
DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194



4214859/B 11/2020

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

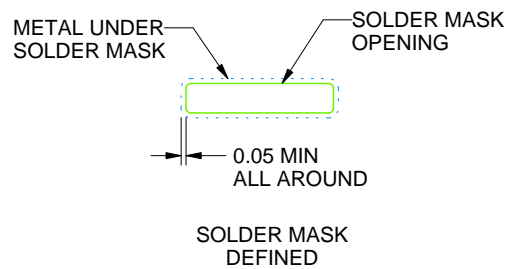
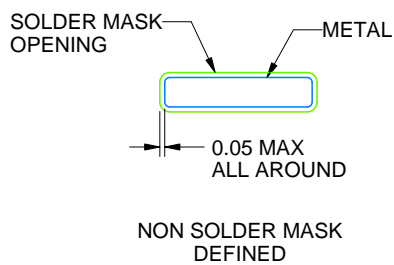
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4214859/B 11/2020

NOTES: (continued)

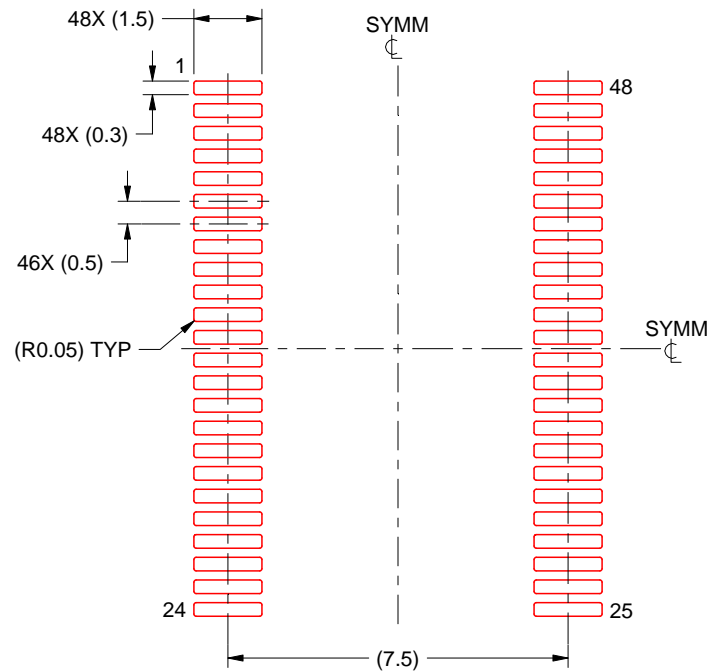
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4214859/B 11/2020

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025